

AMENDMENTS TO THE SPECIFICATION

Page 3, amend paragraph 7 to read:

FIG. 5 is a perspective view of the heat-dissipating device ~~shown in FIG. 4~~
according to another embodiment of the present invention.

Page 3, amend paragraph 8 (bridging pages 3 and 4) to read:

FIGS. 2 and 3 show one embodiment according to the present invention, which relates to a heat-dissipating device made by a metal sheet 2 ~~and~~ being bent to form a plurality of first parts 20 and a plurality of second parts 22, wherein ~~any~~ at least one of the second ~~part~~ parts 22 is disposed between ~~any two of the~~ adjacent first parts 20. The junction between the first part 20 and the second part 22 is bent with an angle enabling any two adjacent first parts 20 to be connected with each other at the corresponding ends distal to the second part 22. As a result, any two adjacent second parts 22 act as two corresponding parallel plates 30 of a heat-dissipating device 3, and the first part 20 therebetween acts as a supporting plate 32 of the heat-dissipating device 3 for supporting the two parallel plates 30 adjacent thereto. Therefore, ~~each unit~~ adjacent sections of the heat-dissipating device 3 ~~is~~ are composed of two parallel plates 30 along with two supporting plates 32 therebetween. While the parallel plates 30 on one side of the heat-dissipating device 3 are in contact with a heat-source, such as a central processing unit of a computer, heat dissipated from the heat-source can be transmitted to the supporting plates 32 and through the supporting plates 32 to the parallel plates 30 on another side thereof for distributing the heat to the outer environment to protect the heat-source from damage due to over heat. Besides, since any two adjacent first parts 20 of the heat-dissipating device 3 are connected at the corresponding ends for supporting with each other, two adjacent first parts 20 strengthen the structure of the heat-dissipating device 3 not easily being crushed by the force acted thereon. Further, the fabrication of the heat-dissipating device 3 directly utilizes stamping and bending skills to form the structure thereof on the metal sheet, which is more convenient than the fabrication of the conventional method via pre-

producing a plurality of U-shaped heat-dissipating sheets and then composing a certain amount of the U-shaped heat-dissipating sheets to form the required heat-dissipating device. Besides, the fabrication of directly bending the metal sheet to form the heat-dissipating device according to the present invention significantly minimize the amount of wasted raw materials being produced than the conventional method.